

TC74ACT540P, TC74ACT541P

1. Functional Description

- Octal Bus Buffer

TC74ACT540P: INVERTED, 3-STATE OUTPUTS

TC74ACT541P: NON-INVERTED, 3-STATE OUTPUTS

2. General

The TC74ACT540P, TC74ACT541P are advanced high speed CMOS OCTAL BUS BUFFERS fabricated with silicon gate and double-layer metal wiring C²MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These devices may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

The TC74ACT540P is an inverting type, and the TC74ACT541P is a non-inverting type.

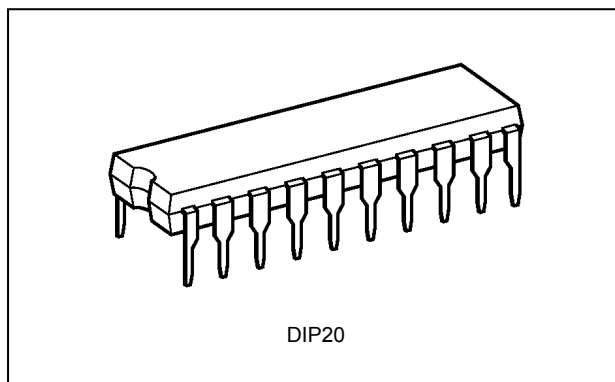
When either $\overline{G1}$ or $\overline{G2}$ are high, the terminal outputs are in the high-impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

- (1) High speed: $t_{pd} = 4.3 \text{ ns}$ (typ.) at $V_{CC} = 5.0 \text{ V}$
- (2) Low power dissipation: $I_{CC} = 8.0 \mu\text{A}$ (max) at $T_a = 25^\circ\text{C}$
- (3) Compatible with TTL input: $V_{IL} = 0.8 \text{ V}$ (max)
 $V_{IH} = 2.0 \text{ V}$ (min)
- (4) Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA}$ (min) ($V_{CC} = 4.5 \text{ V}$)
- (5) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (6) Pin and function compatible with 74F540/541.

4. Packaging

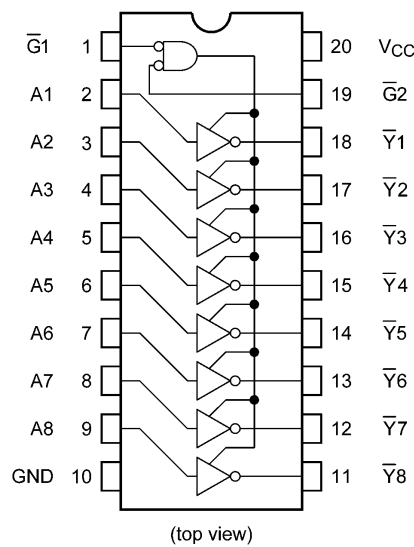


Start of commercial production

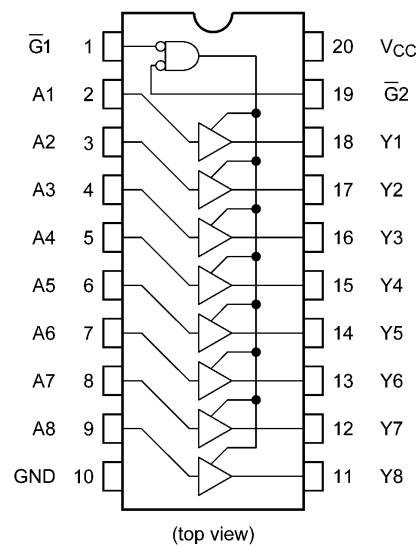
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5. Pin Assignment

TC74ACT540P

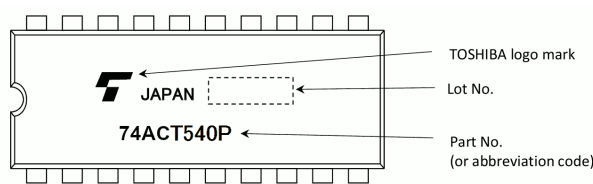


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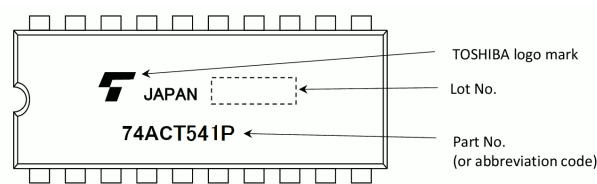


6. Marking

TC74ACT540P

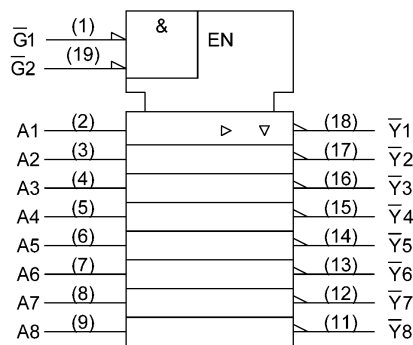


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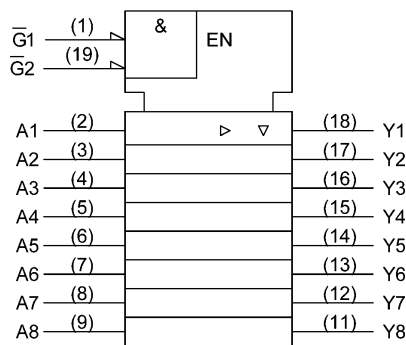


7. IEC Logic Symbol

TC74ACT540P



TC74ACT541P



8. Truth Table

Input $\bar{G}1$	Input $\bar{G}2$	Input A_n	Output Y_n	Output $\bar{Y}_n$
H	X	X	Z	Z
X	H	X	Z	Z
L	L	H	H	L
L	L	L	L	H

X: Don't care

Z: High impedance

Y_n : TC74ACT541P

$\bar{Y}_n$: TC74ACT540P

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}		-0.5 to $V_{CC} + 0.5$	V
Output voltage	V_{OUT}		-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}		± 20	mA
Output diode current	I_{OK}		± 50	mA
Output current	I_{OUT}		± 50	mA
V_{CC} /ground current	I_{CC}		± 200	mA
Power dissipation	P_D	(Note 1)	500	mW
Storage temperature	T_{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of $T_a = -40$ to 65 °C. From $T_a = 65$ to 85 °C a derating factor of -10 mW/°C shall be applied until 300 mW.

10. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	4.5 to 5.5	V
Input voltage	V_{IN}	0 to V_{CC}	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall times	dt/dv	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V_{CC} or GND.

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Typ.	Max	Unit
High-level input voltage	V_{IH}	—	4.5 to 5.5	2.0	—	—	V
Low-level input voltage	V_{IL}	—	4.5 to 5.5	—	—	0.8	V
High-level output voltage	V_{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -50\text{ }\mu\text{A}$	4.5	4.4	4.5	V
			$I_{OH} = -24\text{ mA}$	4.5	3.94	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 50\text{ }\mu\text{A}$	4.5	—	0.0	V
			$I_{OL} = 24\text{ mA}$	4.5	—	0.36	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$	5.5	—	—	± 0.5	μA
Input leakage current	I_{IN}	$V_{IN} = V_{CC} \text{ or GND}$	5.5	—	—	± 0.1	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC} \text{ or GND}$	5.5	—	—	8.0	μA
	I_{CCT}	Per input: $V_{IN} = 3.4\text{ V}$ Other input: $V_{CC} \text{ or GND}$	5.5	—	—	1.35	mA

11.2. DC Characteristics (Unless otherwise specified, $T_a = -40\text{ to }85\text{ }^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	Note	V_{CC} (V)	Min	Max	Unit
High-level input voltage	V_{IH}	—		4.5 to 5.5	2.0	—	V
Low-level input voltage	V_{IL}	—		4.5 to 5.5	—	0.8	V
High-level output voltage	V_{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -50\text{ }\mu\text{A}$	4.5	4.4	—	V
			$I_{OH} = -24\text{ mA}$	4.5	3.80	—	
			$I_{OH} = -75\text{ mA}$ (Note 1)	5.5	3.85	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 50\text{ }\mu\text{A}$	4.5	—	0.1	V
			$I_{OL} = 24\text{ mA}$	4.5	—	0.44	
			$I_{OL} = 75\text{ mA}$ (Note 1)	5.5	—	1.65	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		5.5	—	± 5.0	μA
Input leakage current	I_{IN}	$V_{IN} = V_{CC} \text{ or GND}$		5.5	—	± 1.0	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC} \text{ or GND}$		5.5	—	80.0	μA
	I_{CCT}	Per input: $V_{IN} = 3.4\text{ V}$ Other input: $V_{CC} \text{ or GND}$		5.5	—	1.50	mA

Note 1: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested within a 10 ms maximum duration.

11.3. AC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$, Input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Note	Test Condition	V_{CC} (V)	Min	Typ.	Max	Unit
Propagation delay time	t_{PLH}, t_{PHL}		$C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$	5.0 ± 0.5	—	5.0	8.3	ns
3-state output enable time	t_{PZL}, t_{PZH}		$C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$	5.0 ± 0.5	—	7.3	11.4	ns
3-state output disable time	t_{PLZ}, t_{PHZ}		$C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$	5.0 ± 0.5	—	5.9	9.2	ns
Input capacitance	C_{IN}		—	—	—	5	10	pF
Output capacitance	C_{OUT}		—	—	—	10	—	pF
Power dissipation capacitance	C_{PD}	(Note 1)	TC74ACT540P	—	—	24	—	pF
			TC74ACT541P	—	—	27	—	

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8 \text{ (per bit)}$$

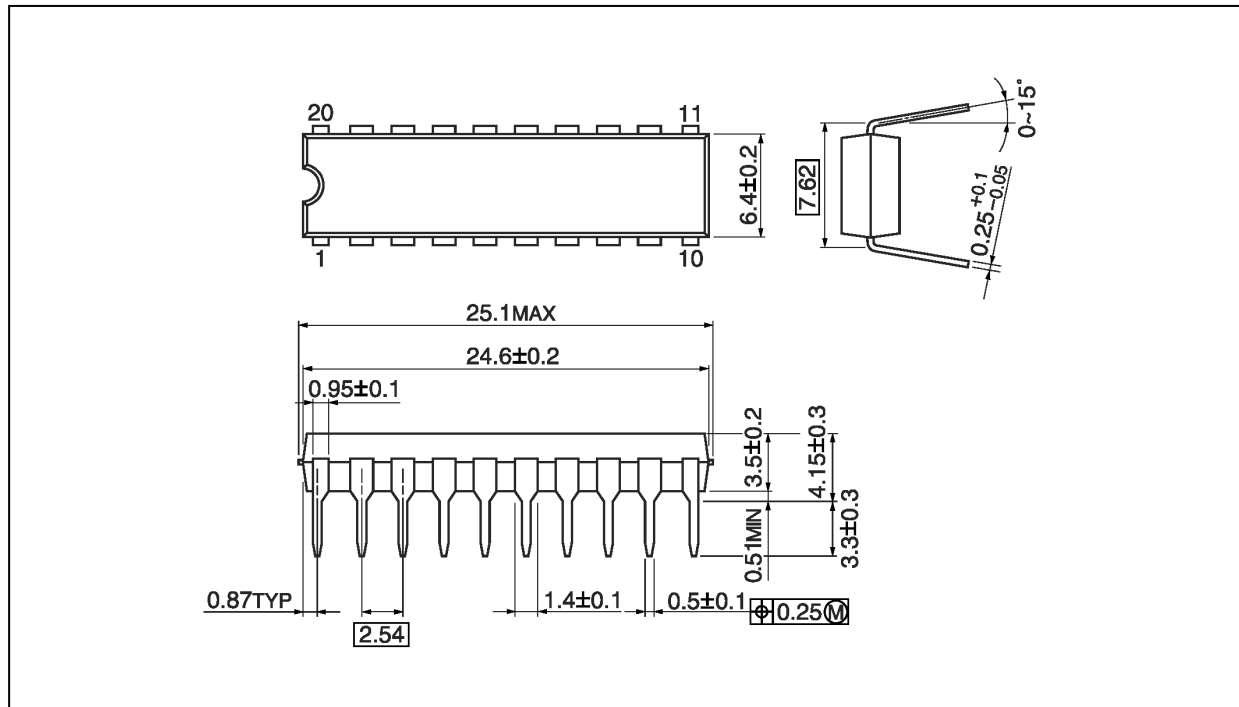
11.4. AC Characteristics

(Unless otherwise specified, $T_a = -40$ to $85\text{ }^\circ\text{C}$, Input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Max	Unit
Propagation delay time	t_{PLH}, t_{PHL}	$C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$	5.0 ± 0.5	1.0	9.5	ns
3-state output enable time	t_{PZL}, t_{PZH}	$C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$	5.0 ± 0.5	1.0	13.0	ns
3-state output disable time	t_{PLZ}, t_{PHZ}	$C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$	5.0 ± 0.5	1.0	10.5	ns
Input capacitance	C_{IN}	—		—	10	pF

Package Dimensions

Unit: mm



Weight: 1.30 g (typ.)

Package Name(s)
Nickname: DIP20

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